IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:

NAKAJYO, Shinsuke et al.

Serial No.: 09/686,958

Filed: October 12, 2000

Group Art Unit: 2824

Examiner: Adam Pyonin

P.T.O. Confirmation No.: 5708

Date: August 29

For. MANUFACTURE OF WAFER LEVEL SEMICONDUCTOR DEVICE AND

SEMICONDUCTOR DEVICE

<u>AMENDMENT</u>

Commissioner for Patents Washington, D.C. 20231

Sir:

In response to the Office Action dated June 4, 2002, please amend the aboveidentified application as set forth below:

IN THE SPECIFICATION:

Amend the specification as follows:

(Page 1, lines 2-3):/ MANUFACTURE OF WAFER LEVEL SEMICONDUCTOR

DEVICE WITH QUALITY MARKINGS ON THE SEALING RESIN